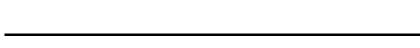
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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR $\mu$ PA2713GR

# SWITCHING P-CHANNEL POWER MOS FET

#### DESCRIPTION

The  $\mu$ PA2713GR is P-channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

#### **FEATURES**

· Low on-state resistance

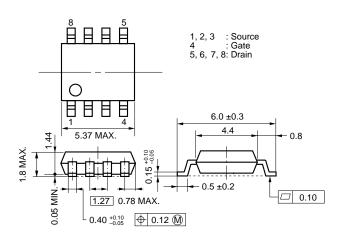
 $R_{DS(on)1}=16~m\Omega$  MAX. (Vgs = -10 V, ID = -4.0 A)  $R_{DS(on)2}=25~m\Omega$  MAX. (Vgs = -4.5 V, ID = -4.0 A)  $R_{DS(on)3}=30~m\Omega$  MAX. (Vgs = -4.0 V, ID = -4.0 A)

- Low Ciss: Ciss = 1600 pF TYP.
- Small and surface mount package (Power SOP8)

#### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA2713GR	Power SOP8

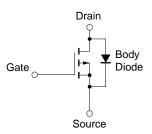
#### PACKAGE DRAWING (Unit: mm)



#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	∓20	V
Drain Current (DC)	I <sub>D(DC)</sub>	∓8	Α
Drain Current (pulse) Note1	ID(pulse)	∓32	Α
Total Power Dissipation Note2	P <sub>T1</sub>	2	W
Total Power Dissipation Note3	P <sub>T2</sub>	2	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note4	las	8	Α
Single Avalanche Energy Note4	Eas	6.4	mJ

#### **EQUIVALENT CIRCUIT**



- **Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%
  - 2. Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm
  - 3. Mounted on a glass epoxy board (1 inch x 1 inch x 0.8 mm), PW = 10 sec
  - **4.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -15 V, R<sub>G</sub> = 25  $\Omega$ , L = 100  $\mu$ H, V<sub>GS</sub> = -20  $\rightarrow$  0 V

**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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#### **ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)**

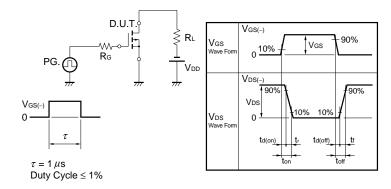
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μΑ
Gate Leakage Current	Igss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			∓100	nA
Gate Cut-off Voltage Note	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.0		-2.5	V
Forward Transfer Admittance Note	<b>y</b> fs	$V_{DS} = -10 \text{ V}, I_{D} = -4.0 \text{ A}$	6	14		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = -10 V, ID = -4.0 A		12	16	mΩ
	RDS(on)2	Vgs = -4.5 V, ID = -4.0 A		17	25	mΩ
	R <sub>DS(on)3</sub>	$V_{GS} = -4.0 \text{ V}, I_{D} = -4.0 \text{ A}$		20	30	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		1600		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		450		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		270		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = -15 V, I <sub>D</sub> = -4.0 A		9		ns
Rise Time	<b>t</b> r	V <sub>GS</sub> = −10 V		15		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		83		ns
Fall Time	<b>t</b> f			43		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -24 V		35		nC
Gate to Source Charge	Qgs	V <sub>GS</sub> = -10 V		4.8		nC
Gate to Drain Charge	Q <sub>GD</sub>	ID = 8 A		10		nC
Body Diode Forward Voltage	V <sub>F(S-D)</sub>	IF = 8 A, VGS = 0 V		0.81		V
Reverse Recovery Time	trr	IF = 8 A, VGS = 0 V		43		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		29		nC

**Note** Pulsed: PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

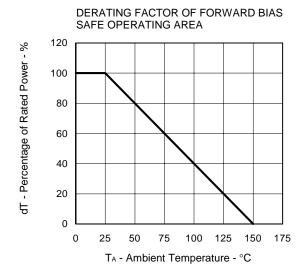
# $V_{GS} = -20 \rightarrow 0 \text{ V}$ $V_{DD}$ $V_{DD}$

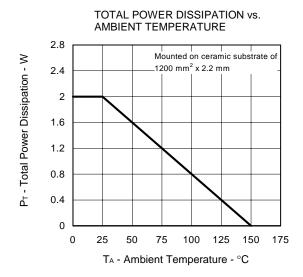
#### **TEST CIRCUIT 2 SWITCHING TIME**



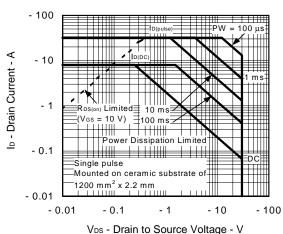
#### **TEST CIRCUIT 3 GATE CHARGE**

#### TYPICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

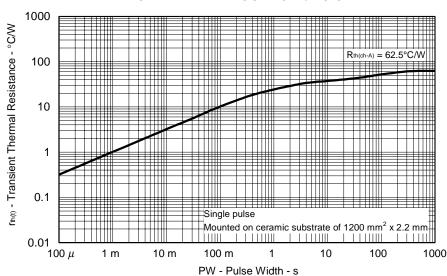




#### FORWARD BIAS SAFE OPERATING AREA

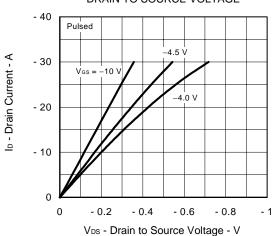


#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

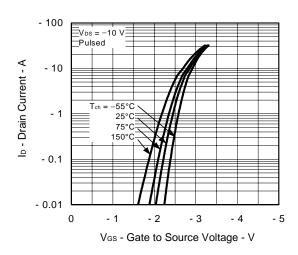


Data Sheet G15981EJ1V0DS 3

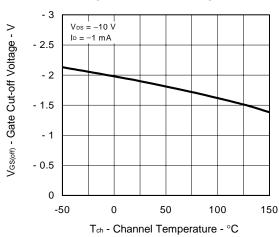
## DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



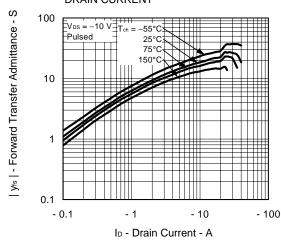
#### FORWARD TRANSFER CHARACTERISTICS



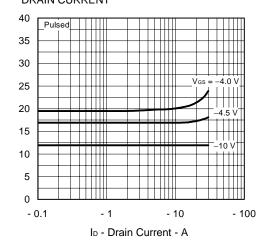
# GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



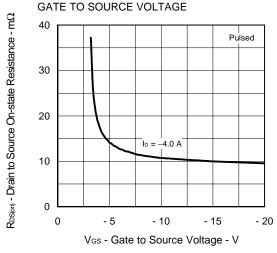
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



# DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

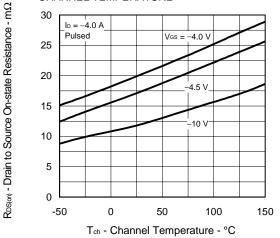


### DRAIN TO SOURCE ON-STATE RESISTANCE vs.

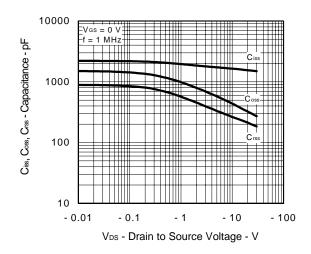


RDS(on) - Drain to Source On-state Resistance - mΩ

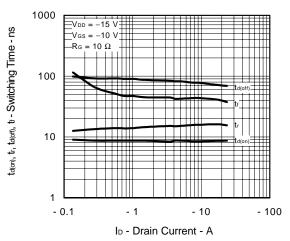
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



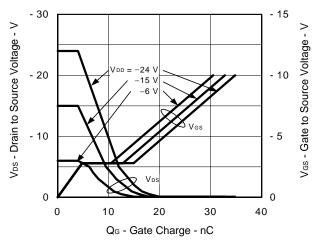
#### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



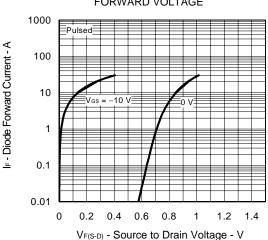
**SWITCHING CHARACTERISTICS** 



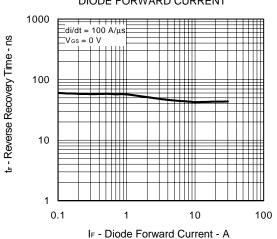
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

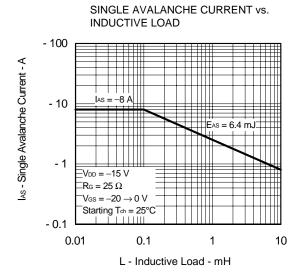


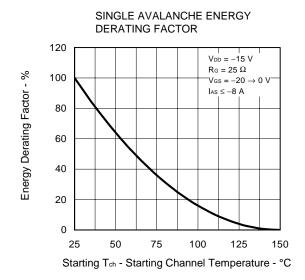
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT







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